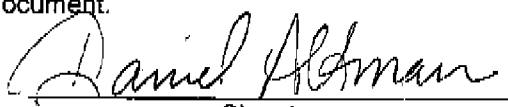


Client Code: CHEPHX.012AUS

**RECORDATION FORM COVER SHEET  
PATENTS ONLY**

To the Director, U.S. Patent and Trademark Office: Please record the attached original documents or copy thereof.

<p>1. Name of conveying party(ies): (List using letters or numbers for multiple parties)</p> <p>1) Sang Hyun Hong    2) Jeong Hwan Ku 3) Su Hak Bae        4) Jin Hwan Choi 5) Jin Hwan Kim      6) Min Soo Lee</p> <p>Additional name(s) of conveying party(ies) attached? ( ) Yes (X) No</p>	<p>2. Name and address of receiving party(ies):</p> <p><b>Name:</b> Cheil Industries, Inc. <b>Street Address:</b> 290, Gongdan-dong, Gumi-shi, Gyung-sangbuk-do, <b>Country:</b> Republic of Korea <b>ZIP:</b> 730-030</p> <p>Additional name(s) of receiving party(ies) attached? ( ) Yes (X) No</p>
<p>3. Nature of conveyance:</p> <p>(X) Assignment            ( ) Security Agreement ( ) Merger                ( ) Change of Name ( ) Other:</p> <p>Execution Date: December 4, 2006</p>	<p>4. US or PCT Application number(s) or US Patent number(s):</p> <p>(X) Patent Application No.: 11/563,648 Filing Date: November 27, 2006</p> <p>Additional numbers attached? ( ) Yes (X) No</p>
<p>5. Party to whom correspondence concerning document should be mailed:</p> <p><b>Customer No.</b> 20,995 <b>Address:</b> Knobbe, Martens, Olson &amp; Bear, LLP 2040 Main Street, 14<sup>th</sup> Floor Irvine, CA 92614 <b>Return Fax:</b> (949) 760-9502 <b>Attorney's Docket No.:</b> CHEPHX.012AUS</p>	<p>6. Total number of applications and patents involved: 1</p>
<p>7. Total fee (37 CFR 1.21(h)): \$40</p> <p>(X) Authorized to be charged to deposit account</p>	<p>8. Deposit account number: 11-1410</p> <p>Please charge this account for any additional fees which may be required, or credit any overpayment to this account.</p>
<p>9. Statement and signature.</p> <p>To the best of my knowledge and belief, the foregoing information is true and correct, and any attached copy is a true copy of the original document.</p> <p>Daniel E. Altman Name of Person Signing</p> <p> Signature</p> <p>3/8/2007 Date</p> <p>34,115 Registration No.</p> <p>Total number of pages including cover sheet, attachments and document: 4</p>	

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Application No.: 11/563,648  
Filing Date: November 27, 2006

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Client Code: CHEPIX.012AUS  
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### ASSIGNMENT

WHEREAS, we, the undersigned, have invented certain new and useful improvements in a **SALT OF CARBOXYETHYL PHOSPHINATE ESTER AND FLAME RETARDANT THERMOPLASTIC RESIN COMPOSITION CONTAINING THE SAME** for which we have executed an application for Letters Patent in the United States, Application No. 11/563,648, Filed on November 27, 2006;

AND WHEREAS, Cheil Industries, Inc. (hereinafter "ASSIGNEE"), a Korean corporation with its principal place of business at 290 Gongdan-dong, Gumi-shi, Gyung-sangbuk-do 730-030, Korea, desires to acquire the entire right, title, and interest in and to the said improvements and the said Application:

NOW, THEREFORE, in view of valuable considerations, the receipt of which is hereby acknowledged, we, the said inventors, do hereby acknowledge that we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, successors, legal representatives and assigns, the entire right, title, and interest throughout the world in, to and under the said improvements, and the said application and all provisional applications relating thereto, and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and we hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said ASSIGNEE, successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE DO HEREBY sell, assign, transfer, and convey to ASSIGNEE, his successors, legal representatives, and assigns all claims for damages and all remedies arising out of any violation of the rights assigned hereby that may have accrued prior to the date of assignment to ASSIGNEE, or may accrue hereafter, including, but not limited to, the right to sue for, collect, and retain damages for past infringements of the said Letters Patent before or after issuance.

AND WE HEREBY covenant and agree that we will communicate to the said ASSIGNEE, successors, legal representatives and assigns, any facts known to us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

Full name of inventor: HONG, Sang Hyun

Date: 2006. 12. 4

Inventor's signature : [Signature]

Residence: 109/1903, Hanjinroshill Apartment, Ojeon-dong, Uijeong-si, Gyeonggi-do, 437-750, Republic of Korea

Full name of inventor: KU, Jeong Hwan

Date: 2006. 12. 4

Inventor's signature : [Signature]

Residence: 509/1106, Gaya Jugong Apartment, Sanbon-Dong, Gumpo-Si, Gyeonggi-Do, 435-040, Republic of Korea

Application No.: 11/563,648  
Filing Date: November 27, 2006

PATENT  
Client Code: CHEPIX.012AUS  
Page 2

Full name of inventor: BAE, Su Hak

Date: 2006.12.04

Inventor's signature: [Signature]

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Full name of inventor: CHOL Jin Hwan

Date: 2006.12.04

Inventor's signature: [Signature]

Residence: 10/903, Bisan Sambo Apartment 245, Bisan-3Dong, Dongan-Gu, Anyang-Si, Gyeonggi-Do, 431-737, Republic of Korea

Full name of inventor: KIM, Jin Hwan

Date: 2006.12.04

Inventor's signature: [Signature]

Residence: 9-309 Sampung Apartment, Seocho-Dong, Seocho-Gu, Seoul, 137-070 Republic of Korea

Full name of inventor: LEE, Min Soo

Date: 2006.12.04

Inventor's signature: [Signature]

Residence: 33-903 Hanyang Apartment, Bono-2dong, Sangnok-gu, Ansan-si, Gyeonggi-do, 426-730, Republic of Korea

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